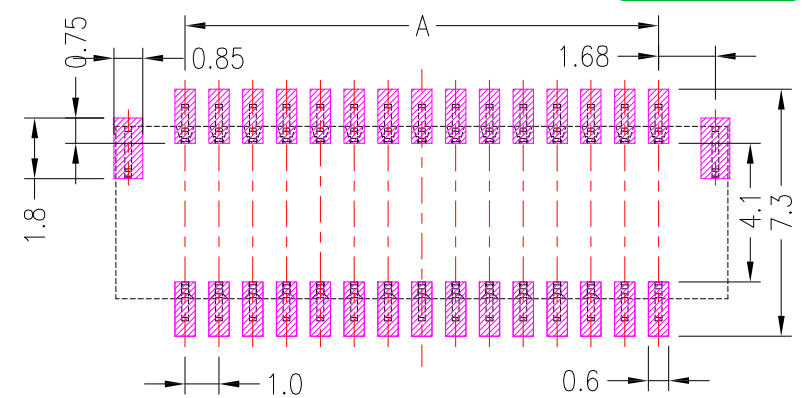
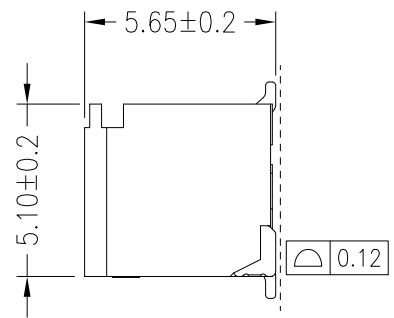
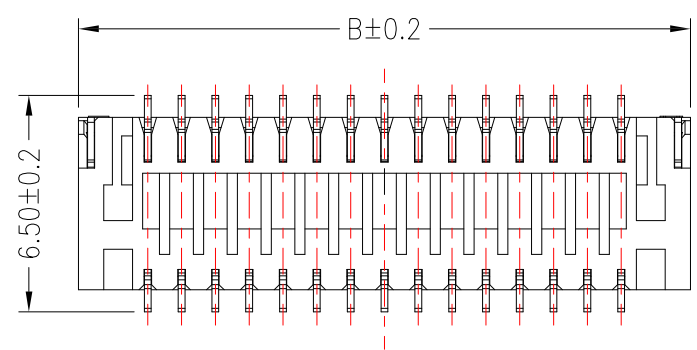
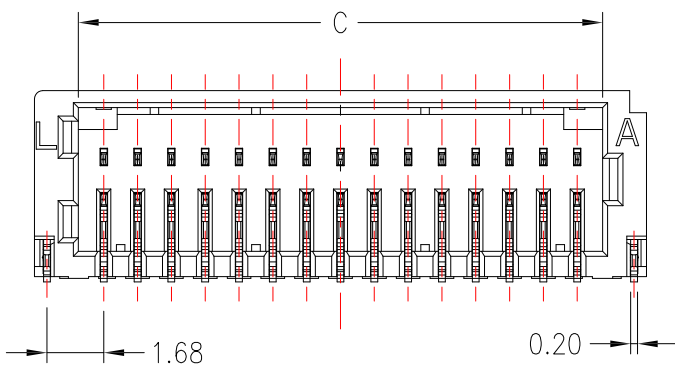
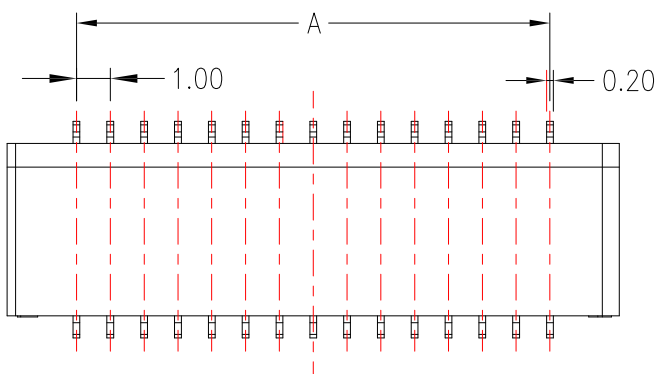




P.C.B LAYOUT

芯数	A	B	C
10	4.0	8.1	5.5
12	5.0	9.1	6.5
14	6.0	10.1	7.5
16	7.0	11.1	8.5
18	8.0	12.1	9.5
20	9.0	13.1	10.5
22	10.0	14.1	11.5
24	11.0	15.1	12.5
30	14.0	18.1	15.5
40	19.0	23.1	20.5
50	24.0	28.1	25.5

1.MATERIAL

- 1.1 HOUSING: PA9T,NATURAL
- 1.2 CONTACT:PHOSPHOR BRONZE, AU OR TIN PLATED OVER NICKEL
- 1.3 SOLDER TABS:BRASS,TIN PLATED OVER NICKEL

2.SPECIFICATION

- 2.1 CURRENT RATING:1.0A AC,DC
- 2.2 VOLTAGE RATING:50V AC,DC
- 2.3 TEMPERATURE RANGE:-25C~+85C
- 2.4 CONTACT RESISTANCE:20MΩ MAX.
- 2.5 INSULATION RESISTANCE:100MΩ MIN.
- 2.6 WITHSTANDING VOLTAGE:500V AC/MINUTE

ITEM NO.	DESCRIPTION	DRAWN	DATE



建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED :	Up to 5 ±0.2 Above 5 ~ 15 ±0.3 Above 15 ~ 30 ±0.4 Above 30 ~ 50 ±0.5 Angle ±0.3°	3RD. ANGEL'S		UNITS	MM
-------------------------------------	--	--------------	--	-------	----

DRAWN BY:	DATE	MAT'L		TITLE	CONNECTOR
Jack Lu	05/15/25	FINISH		MODLE	WAFER 1.0 SMT 90度
CHECKED BY:	DATE	SCALE	1 : 1	DWG NO.	WF-1007RSxx-S304
Jacky Chen	05/15/25	SHEET NO.	1 of 1	PART NO.	WF-1007RSxx-S304
APPROVED BY:	DATE				
Tony Kao	05/15/25				